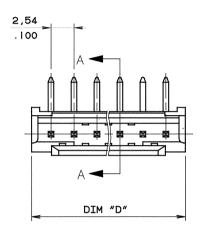
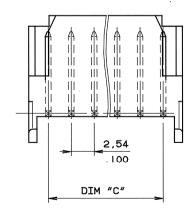
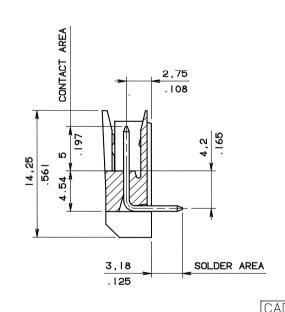
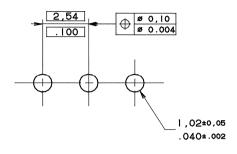
1	PRODUCT NUMBER	N° OF POS.	DIM"C"	DIM"D"		
	77331-Y04	04	7.62/.300	11.92/.469		
	77331-Y05	05	10.16/.400	14.46/.569		
	77331-Y06	06	12.70/.500	17.00/.669		





77331-4XX





RECOMMENDED HOLE PATTERN

## NOTES :

- I MATERIAL BODY : THERMOPLASTIC POLYESTER , 30% GLASS FILLED COLOUR BLUE , FLAME RETARDANT PER UL-94-V0 .
  - MATERIAL PINS : PHOSPHOR BRONZE 3/4 HARD
- 2 MINIMUM PUSH-OUT FORCE : 22 NEWTONS .
- 3 SEE TABLE FOR DIM"C" AND "D"

SECTION	A-A
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SnPb OVER No



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S	URFACE BO 1302		TOLERANCE ISO 406 ISO 1101				4	\$_		$\overline{1}$	INCH		MATL CODE SEE NOTE 1				
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ū	ECP	N	D	ATE		DR	SUPS	D BY	′			SUPER	RSEDES		REL	EASE N 21	95

SnPb MIN. OVER  $\frac{1.3 \mu m}{50 \mu''}$  N( MIN . 4 μm 160 μ" 0.75 µm Au MIN. OVER SnPb OVER Nt 77331-3XX 30 μ" PLATING CODE CONTACT AREA SOLDER TAIL PLATING EXPLANATION